

TL971-Q1

RAIL-TO-RAIL OUTPUT, VERY LOW-NOISE OPERATIONAL AMPLIFIERS

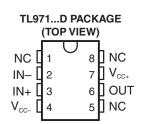
Check for Samples: TL971-Q1, TL972-Q1, TL974-Q1

FEATURES

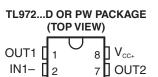
- Qualified for Automotive Applications
- Rail-to-Rail Output Voltage Swing: ±2.4 V at V_{CC} = ±2.5 V
- Very Low Noise Level: 4 nV/VHz
- Ultra-Low Distortion: 0.003%
- High Dynamic Features: 12 MHz, 5 V/µs
- Operating Range: 2.7 V to 12 V
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B)
 - 200-V Machine Model (A115-A)
 - 1500-V Charged-Device Model (C101)

APPLICATIONS

- Portable Equipment (CD Players, PDAs)
- Portable Communications (Cell Phones, Pagers)
- Instrumentation and Sensors
- Professional Audio Circuits



NC - No internal connection



IN1+ [] 3 V _{cc-} [] 4		
TL974PW	PACKAGE /IEW)	

OUT1 IN1- IN1+ V _{cc+}	2	13 12] OUT4] IN4–] IN4+] V _{cc-}
IN2+ IN2– OUT2	6	10	1N3+ IN3– IN3– OUT3

DESCRIPTION/ORDERING INFORMATION

The TL97x family of operational amplifiers operates at voltages as low as ± 1.35 V and features output rail-to-rail signal swing. The TL97x boast characteristics that make them particularly well suited for portable and battery-supplied equipment. Very low noise and low distortion characteristics make them ideal for audio preamplification.

T _A	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	TL971QDRQ1	TL971Q
40°C to 125°C	TL972QDRQ1	TL972Q
–40°C to 125°C	TL972QPWRQ1	TL972Q
	TL974QPWRQ1	TL974Q

ORDERING INFORMATION⁽¹⁾⁽²⁾

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

	poraling nee an temperature range (amose etherwi			
V _{CC}	Supply voltage range ⁽²⁾			2.7 V to 15 V
V_{ID}	Differential input voltage ⁽³⁾			±1 V
V _{IN}	Input voltage range ⁽⁴⁾		$V_{CC-}{-}0.3$ V to V_{CC+} + 0.3 V	
		D package ⁽⁵⁾	8 pin	97°C/W
θ_{JA}	Package thermal impedance, junction to free air	$\mathbf{D}\mathbf{M}$ = a shear \mathbf{a} (5)	8 pin	149°C/W
		PW package ⁽⁵⁾	14 pin	113°C/W
TJ	Maximum junction temperature			150°C
T _{lead}	Maximum lead temperature	Soldering, 10 seco	onds	260°C
T _{stg}	Storage temperature range			–65°C to 150°C
		Human-Body Mode	el (HBM)	2000 V
ESD	Electrostatic discharge protection	Machine Model (M	M)	200 V
		Charged-Device M	lodel (CDM)	1500 V

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating" conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

All voltage values, except differential voltages, are with respect to network ground terminal. (2)

Differential voltages for the noninverting input terminal are with respect to the inverting input terminal. (3)

(0) (4) (5) The input and output voltages must never exceed V_{CC} + 0.3 V.

Package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
V _{CC}	Supply voltage	2.7	12	V
VICM	Common-mode input voltage	V _{CC-} + 1.15	V _{CC+} – 1.15	V
T _A	Operating free-air temperature	-40	125	°C



TL971-Q1 TL972-Q1 TL974-Q1 SLOS632A – MARCH 2009 – REVISED SEPTEMBER 2012

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ELECTRICAL CHARACTERISTICS

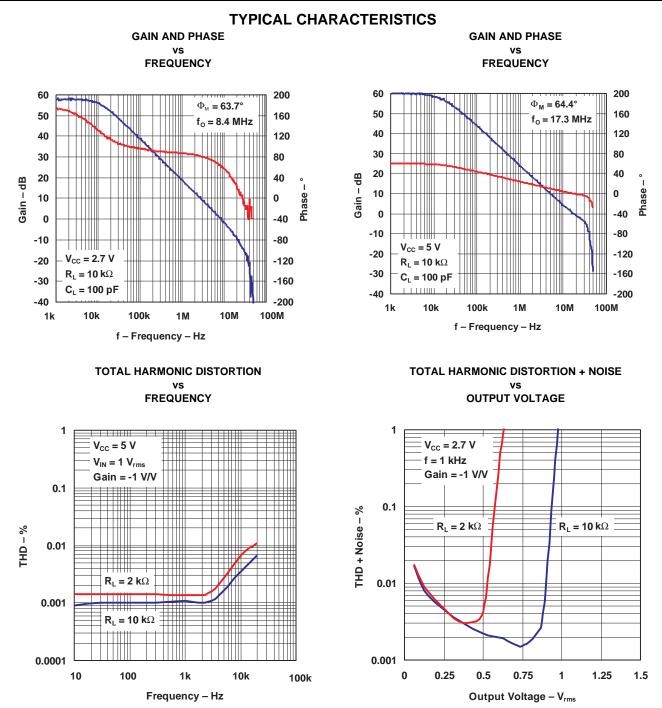
 $V_{CC+} = 2.5 \text{ V}, V_{CC-} = -2.5 \text{ V}$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	T _A ⁽¹⁾	MIN	TYP	MAX	UNIT
V _{IO} Input offset voltage			25°C		1	4	
VIO	Input offset voltage		Full range			6	mV
αV _{IO}	Input offset voltage drift	V _{ICM} = 0 V, V _O = 0 V	25°C		5		µV/°C
I _{IO}	Input offset current	V _{ICM} = 0 V, V _O = 0 V	25°C		10	150	nA
	land king annual		25°C		200	750	
I _{IB}	Input bias current	$V_{ICM} = 0 V, V_O = 0 V$	Full range			1000	nA
V _{ICM}	Common-mode input voltage		25°C	-1.35		1.35	V
CMRR	Common-mode rejection ratio	V _{ICM} = ±1.35 V	25°C	60	85		dB
SVR	Supply-voltage rejection ratio	$V_{CC} = \pm 2 V \text{ to } \pm 3 V$	25°C	60	70		dB
A _{VD}	Large-signal voltage gain	$R_L = 2 k\Omega$	25°C	70	80		dB
V _{OH}	High-level output voltage	$R_L = 2 k\Omega$	25°C	2	2.4		V
V _{OL}	Low-level output voltage	$R_L = 2 k\Omega$	25°C		-2.4	-2	V
	Output source current		25°C	1.2	1.4		
source		V _{OUT} shorted to –2.5 V	Full range	1			mA
			25°C	50	80		
I _{sink}	Output sink current	V _{OUT} shorted to +2.5 V	Full range	25			mA
		Linity ania. No local	25°C		2	2.8	
I _{CC}	Supply current (per amplifier)	Unity gain, No load	Full range			3.2	mA
GBWP	Gain bandwidth product	f = 100 kHz, R_L = 2 kΩ, C_L = 100 pF	25°C	8.5	12		MHz
0.0	Olemente		25°C	3.5	5		Maria
SR Slew rate		$A_V = 1, V_{IN} = \pm 1 V$	Full range	3			V/µs
Φm	Phase margin at unity gain	$R_{L} = 2 k\Omega, C_{L} = 100 pF$	25°C		60		0
Gm	Gain margin	$R_L = 2 k\Omega$, $C_L = 100 pF$	25°C		10		dB
V _n	Equivalent input noise voltage	f = 100 kHz	25°C		4		nV/√Hz
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_v = -1, R_L = 10 \text{ k}\Omega$	25°C		0.003		%

(1) Full range $T_A = -40^{\circ}C$ to $125^{\circ}C$



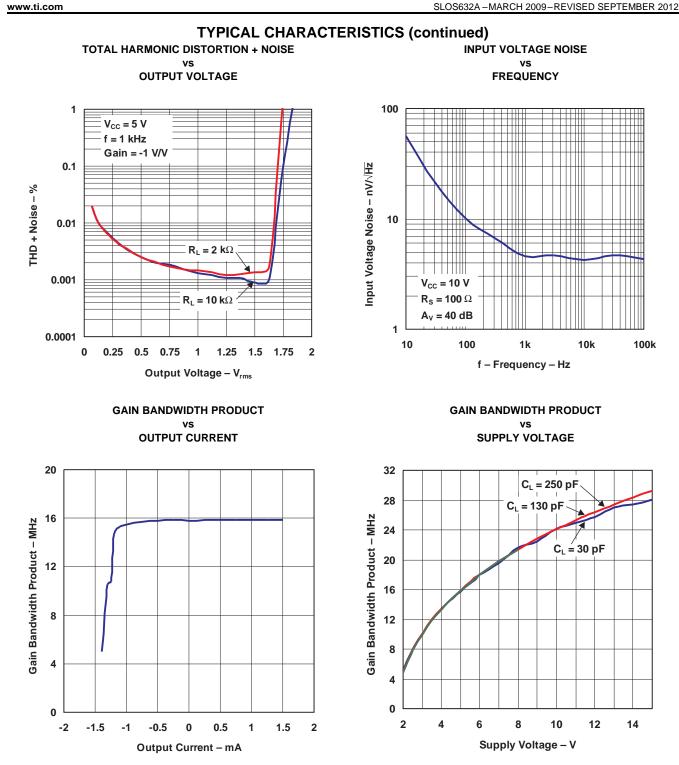




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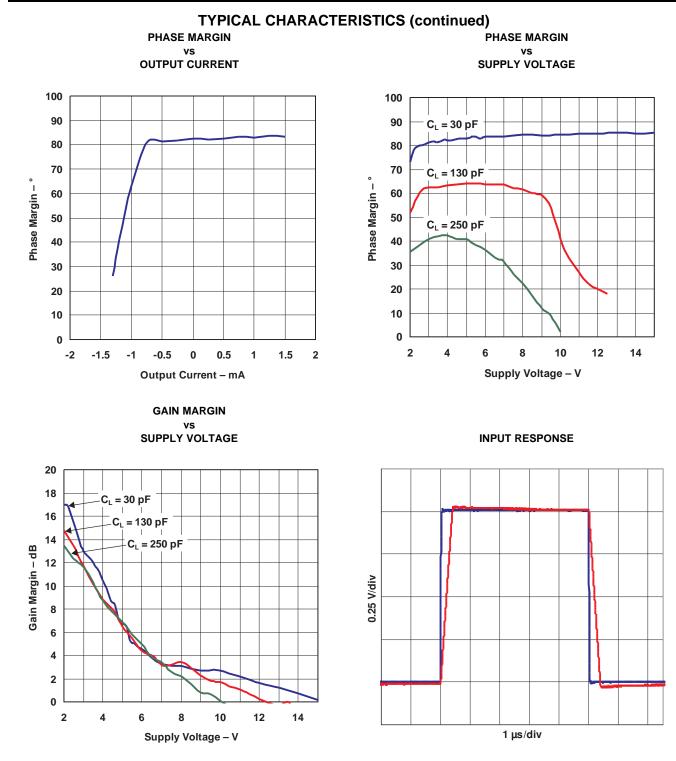


TL971-Q1 TL972-Q1 TL974-Q1 SLOS632A – MARCH 2009–REVISED SEPTEMBER 2012







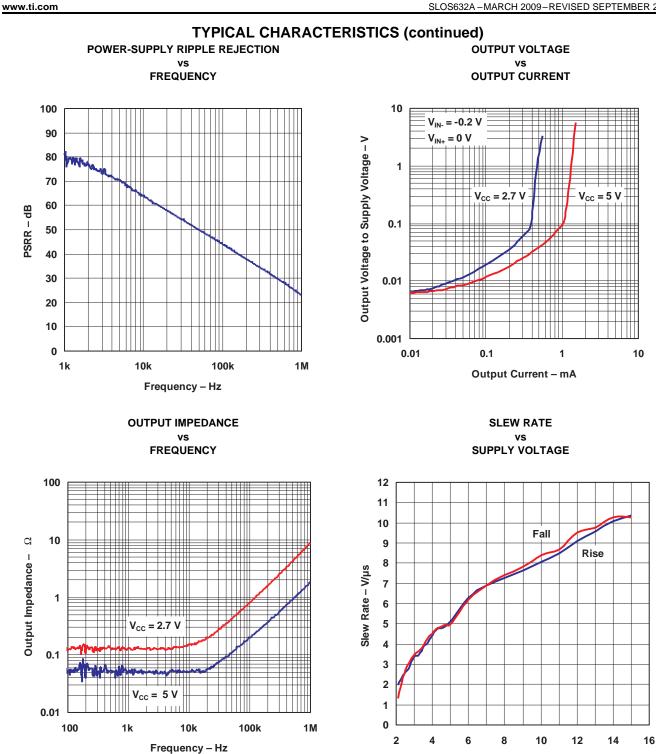


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TL971-Q1 TL972-Q1 TL974-Q1 SLOS632A – MARCH 2009–REVISED SEPTEMBER 2012



Supply Voltage - V



REVISION HISTORY

Cł	Changes from Original (March 2009) to Revision A Page					
•	Removed packaging column from the ordering information table.	1				
•	Changed $V_{OUT} = \pm 2.5$ V to V_{OUT} shorted to -2.5 V for I _{source} , and changed $V_{OUT} = \pm 2.5$ V to V_{OUT} shorted to +2.5 V for I _{sink} .	3				

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PACKAGING INFORMATION

Orderable Device		Package Type	Package Drawing	Pins	Package Qty		Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		aly	(2)	(6)	(3)		(4/5)	
TL971QDRQ1	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL971Q	Samples
TL972QDRQ1	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL972Q	Samples
TL972QPWRQ1	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL972Q	Samples
TL974QPWRQ1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL974Q	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF TL971-Q1, TL972-Q1, TL974-Q1 :

• Catalog: TL971, TL972, TL974

NOTE: Qualified Version Definitions:

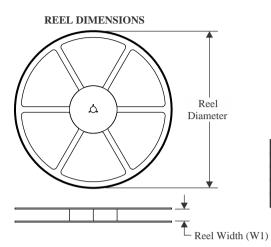
• Catalog - TI's standard catalog product

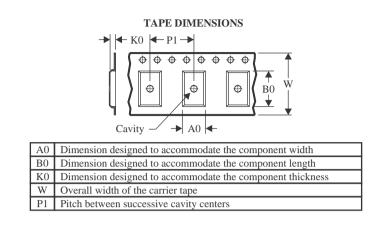


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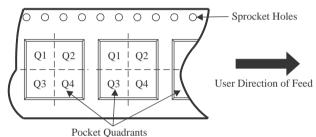
STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

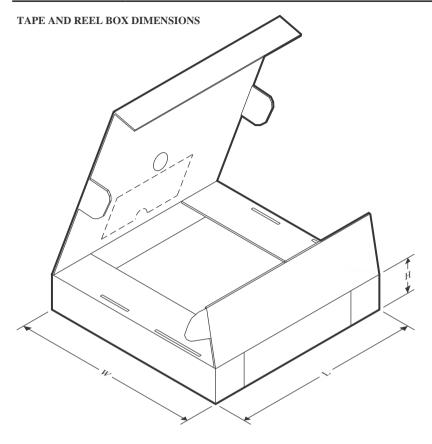


*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL972QDRQ1	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL972QPWRQ1	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
TL974QPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



PACKAGE MATERIALS INFORMATION

3-Jun-2022



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL972QDRQ1	SOIC	D	8	2500	340.5	336.1	25.0
TL972QPWRQ1	TSSOP	PW	8	2000	356.0	356.0	35.0
TL974QPWRQ1	TSSOP	PW	14	2000	356.0	356.0	35.0

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



A. An integration of the information o

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



D0008A



PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.

- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



D0008A

EXAMPLE BOARD LAYOUT

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



D0008A

EXAMPLE STENCIL DESIGN

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



PW0008A



PACKAGE OUTLINE

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153, variation AA.



PW0008A

EXAMPLE BOARD LAYOUT

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



PW0008A

EXAMPLE STENCIL DESIGN

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

9. Board assembly site may have different recommendations for stencil design.



^{8.} Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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